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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

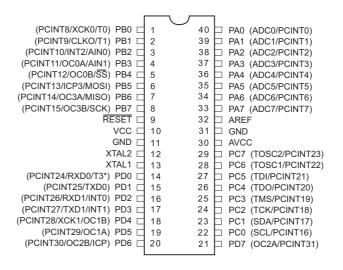
Applications of "<u>Embedded - Microcontrollers</u>"

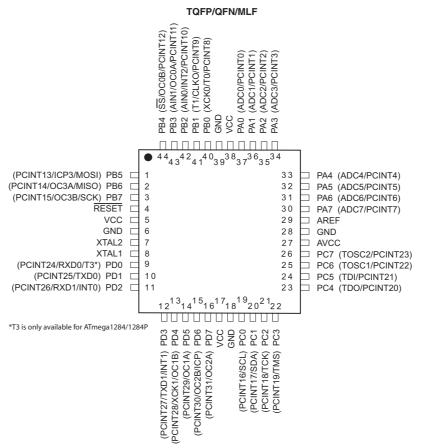
Product Status Active Core Processor AVR Core Size 8-Bit Speed 20MHz Connectivity I²C, SPI, UART/USART Peripherals Brown-out Detect/Reset, PO Number of I/O 32 Program Memory Size 16KB (8K x 16) Program Memory Type FLASH EEPROM Size 512 x 8 RAM Size 1K x 8 Voltage - Supply (Vcc/Vdd) 1.8V ~ 5.5V Data Converters A/D 8x10b Oscillator Type Internal Operating Temperature -40°C ~ 85°C (TA) Mounting Type Surface Mount Package / Case 44-VFQFN Exposed Pad Supplier Device Package 44-VQFN (7x7)	
Core Processor Core Size 8-Bit Speed 20MHz Connectivity Peripherals Brown-out Detect/Reset, PO Number of I/O 32 Program Memory Size 16KB (8K x 16) Program Memory Type FLASH EEPROM Size 1512 x 8 RAM Size Voltage - Supply (Vcc/Vdd) 1.8V ~ 5.5V Data Converters A/D 8x10b Oscillator Type Internal Operating Temperature Package / Case AVR 8-Bit 9-10-SATT 16KB (8K x 16) 8-LASH 16KB (8K x 16	
Core Size Speed 20MHz Connectivity I²C, SPI, UART/USART Peripherals Brown-out Detect/Reset, PO Number of I/O 32 Program Memory Size 16KB (8K x 16) Program Memory Type FLASH EEPROM Size 512 x 8 RAM Size Voltage - Supply (Vcc/Vdd) 1.8V ~ 5.5V Data Converters A/D 8x10b Oscillator Type Internal Operating Temperature -40°C ~ 85°C (TA) Mounting Type Surface Mount Package / Case	
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Mounting Type Surface Mount Package / Case 44-VFQFN Exposed Pad	
Package / Case 44-VFQFN Exposed Pad	
<u> </u>	
Supplier Device Package 44-VQFN (7x7)	
Purchase URL https://www.e-xfl.com/produ	ıct-detail/microchip-technology/atmega164a-mu

1. Pin configurations

1.1 Pinout - PDIP/TQFP/VQFN/QFN/MLF for ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P

Figure 1-1. Pinout.





Note: The large center pad underneath the VQFN/QFN/MLF package should be soldered to ground on the board to ensure good mechanical stability.



1.3 Pinout - VFBGA for Atmel ATmega164A/164PA/324A/324PA

Figure 1-3. VFBGA - pinout.

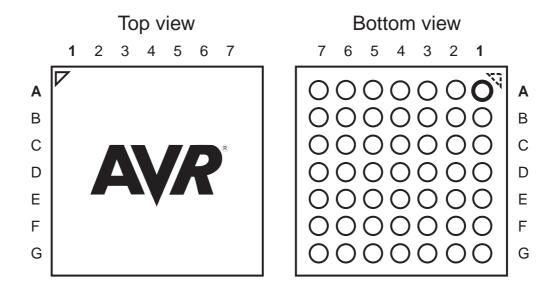


Table 1-2. BGA - pinout.

GND	PB4	PB2	GND	VCC	PA2	GND
PB6	PB5	PB3	PB0	PA0	PA3	PA5
VCC	RESET	PB7	PB1	PA1	PA6	AREF
GND	XTAL2	PD0	GND	PA4	PA7	GND
XTAL1	PD1	PD5	PD7	PC5	PC7	AVCC
PD2	PD3	PD6	PC0	PC2	PC4	PC6
GND	PD4	VCC	GND	PC1	PC3	GND

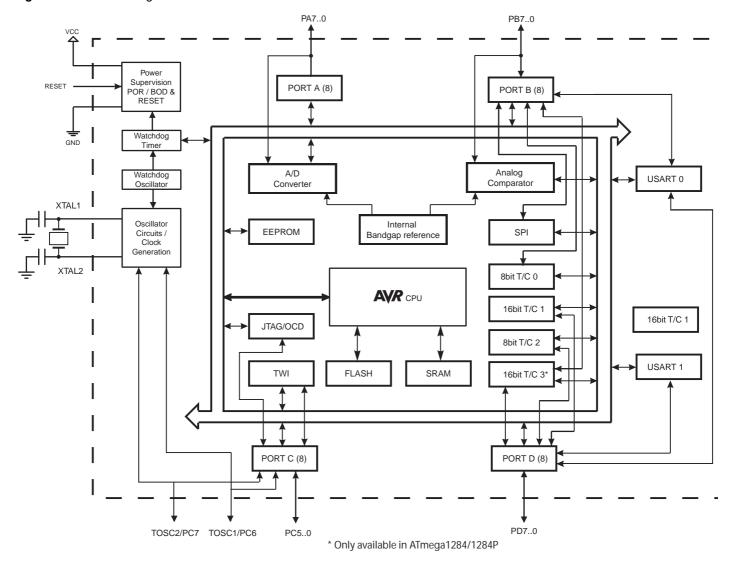
2. Overview

The Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284P is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.



2.1 Block diagram

Figure 2-1. Block diagram.



The AVR core combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284P provide the following features:

16/32/64/128Kbytes of In-System Programmable Flash with Read-While-Write capabilities, 512/1K/2K/4Kbytes EEPROM, 1/2/4/16Kbytes SRAM, 32 general purpose I/O lines, 32 general purpose working registers, Real Time Counter (RTC), three (four for ATmega1284/1284P) flexible Timer/Counters with compare modes and PWM, 2 USARTs, a byte oriented two-wire Serial Interface, a 8-channel, 10-bit ADC with optional differential input stage with programmable gain, programmable Watchdog Timer with Internal Oscillator, an SPI serial port, IEEE std. 1149.1 compliant JTAG test interface, also used for accessing the On-chip Debug system and programming and six software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, Timer/Counters, SPI port, and interrupt system to continue functioning. The Power-down mode saves the register contents but freezes the Oscillator, disabling all other chip functions until the next interrupt or Hardware Reset. In Power-save mode, the asynchronous timer continues to run, allowing the user to maintain a



timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except Asynchronous Timer and ADC, to minimize switching noise during ADC conversions. In Standby mode, the Crystal/Resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run.

Atmel offers the QTouch[®] library for embedding capacitive touch buttons, sliders and wheels functionality into AVR microcontrollers. The patented charge-transfer signal acquisition offers robust sensing and includes fully debounced reporting of touch keys and includes Adjacent Key Suppression[®] (AKS™) technology for unambiguous detection of key events. The easy-to-use QTouch Suite toolchain allows you to explore, develop and debug your own touch applications.

The device is manufactured using Atmel's high-density nonvolatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed in-system through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The boot program can use any interface to download the application program in the application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P is a powerful microcontroller that provides a highly flexible and cost effective solution to many embedded control applications.

The ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, in-circuit emulators, and evaluation kits.

2.2 Comparison between ATmega164A, ATmega164PA, ATmega324A, ATmega324PA, ATmega644A, ATmega644PA, ATmega1284 and ATmega1284P

Table 2-1. Differences between ATmega164A, ATmega164PA, ATmega324PA, ATmega324PA, ATmega644A, ATmega644PA, ATmega1284 and ATmega1284P.

	<u> </u>			
Device	Flash	EEPROM	RAM	Units
ATmega164A	16K	512	1K	
ATmega164PA	16K	512	1K	
ATmega324A	32K	1K	2K	
ATmega324PA	32K	1K	2K	hytaa
ATmega644A	64K	2K	4K	bytes
ATmega644PA	64K	2K	4K	
ATmega1284	128K	4K	16K	
ATmega1284P	128K	4K	16K	

2.3 Pin Descriptions11

2.3.1 VC

Digital supply voltage.

2.3.2 GND

Ground.



2.3.3 Port A (PA7:PA0)

Port A serves as analog inputs to the Analog-to-digital Converter.

Port A also serves as an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port A pins that are externally pulled low will source current if the pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port A also serves the functions of various special features of the Atmel

ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 79.

2.3.4 Port B (PB7:PB0)

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tristated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the

ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 80.

2.3.5 Port C (PC7:PC0)

Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tristated when a reset condition becomes active, even if the clock is not running.

Port C also serves the functions of the JTAG interface, along with special features of the Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 83.

2.3.6 Port D (PD7:PD0)

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tristated when a reset condition becomes active, even if the clock is not running.

Port D also serves the functions of various special features of the

ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 86.

2.3.7 **RESET**

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in "" on page 325. Shorter pulses are not guaranteed to generate a reset.

2.3.8 XTAL1

Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

2.3.9 XTAL2

Output from the inverting Oscillator amplifier.

2.3.10 AVCC

AVCC is the supply voltage pin for Port A and the Analog-to-digital Converter. It should be externally connected to V_{CC} , even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter.

2.3.11 AREF

This is the analog reference pin for the Analog-to-digital Converter.



3. Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.

4. About code examples

This documentation contains simple code examples that briefly show how to use various parts of the device. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Please confirm with the C compiler documentation for more details.

The code examples assume that the part specific header file is included before compilation. For I/O registers located in extended I/O map, "IN", "OUT", "SBIS", "SBIC", "CBI", and "SBI" instructions must be replaced with instructions that allow access to extended I/O. Typically "LDS" and "STS" combined with "SBRS", "SBRC", "SBR", and "CBR".

5. Data retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.

6. Capacitive touch sensing

The Atmel QTouch Library provides a simple to use solution to realize touch sensitive interfaces on most Atmel AVR microcontrollers. The QTouch Library includes support for the QTouch and QMatrix acquisition methods.

Touch sensing can be added to any application by linking the appropriate Atmel QTouch Library for the AVR Microcontroller. This is done by using a simple set of APIs to define the touch channels and sensors, and then calling the touch sensing API's to retrieve the channel information and determine the touch sensor states.

The QTouch Library is FREE and downloadable from the Atmel website at the following location: www.atmel.com/qtouchlibrary. For implementation details and other information, refer to the Atmel QTouch Library User Guide - also available for download from the Atmel website.



7. Register summary

									1	
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(0xFF)	Reserved	-	-	-	-		-	-	-	
(0xFE)	Reserved	-	-	-	-	-	-	-	-	
(0xFD)	Reserved	-	-	-	-	-	-	-	-	
(0xFC)	Reserved	-	-	-	-	-	-	-	-	
(0xFB)	Reserved	-	-	-	-		-	-	-	
(0xFA)	Reserved	-	-	-	-	-	-	-	-	
(0xF9)	Reserved	-	-	-	-		-	-	-	
(0xF8)	Reserved	-	-	-	-	-	-	-	-	
(0xF7)	Reserved	-	-	-	-	-	-	-	-	
(0xF6)	Reserved	-	-	-	-	-	-	-	-	
(0xF5)	Reserved	-	-	-	-		-	-	-	4
(0xF4)	Reserved	-	-	-	-	-	-	-	-	
(0xF3)	Reserved	-	-	-	-	-	-	-	-	
(0xF2)	Reserved	-	-	-	-	-	-	-	-	
(0xF1)	Reserved	-	-	-	-		-	-	-	
(0xF0)	Reserved	-	-	-	-	-	-	-	-	
(0xEF)	Reserved	-	-	-	-		-	-	-	
(0xEE)	Reserved	-	-	-	-	-	-	-	-	
(0xED)	Reserved	-	-	-	-	-	-	-	-	
(0xEC)	Reserved	-	-	-	-	-	-	-	-	
(0xEB)	Reserved	-	-	-	-		-	-	-	
(0xEA)	Reserved	-	-	-	-	-	-	-	-	
(0xE9)	Reserved	-	-	-	-	-	-	-	-	
(0xE8)	Reserved	-	-	-	-	-	-	-	-	
(0xE7)	Reserved	-	-	-	-		-	-	-	
(0xE6)	Reserved	-	-	-	-	-	-	-	-	
(0xE5)	Reserved	-	-	-	-	-	-	-	-	
(0xE4)	Reserved	-	-	-	-	-	-	-	-	
(0xE3)	Reserved	-	-	-	-		-	-	-	
(0xE2)	Reserved	-	-	-	-	-	-	-	-	
(0xE1)	Reserved	-	-	-	-		-	-	-	
(0xE0)	Reserved	-	-	-	-		-	-	-	_
(0xDF)	Reserved	-	-	-	-	-	-	-	-	
(0xDE)	Reserved	-	-	-	-	-	-	-	-	
(0xDD)	Reserved	-	-	-	-	-	-	-	-	
(0xDC)	Reserved	-	-	-	-		-	-	-	
(0xDB)	Reserved	-	-	-	-	-	-	-	-	
(0xDA)	Reserved	-	-	-	-	-	-	-	-	1
(0xD9)	Reserved	-	-	-	-	-	-	-	-	
(0xD8)	Reserved Reserved	-	-	-	-	-	-	-	-	1
(0xD7) (0xD6)	Reserved		-	-	-	-	-	-	-	1
	1	-				-				-
(0xD5)	Reserved Reserved	-	-	-	-	-	-	-	-	+
(0xD4) (0xD3)	Reserved	-	-	-	-	-	-	-	-	+
(0xD3) (0xD2)	Reserved	-	-	-	_			-	-	1
(0xD2) (0xD1)	Reserved	-	-	-	-	-	-	-	-	+
(0xD1) (0xD0)	Reserved	-	-	-	-	-	-	-	-	+
(0xCF)	Reserved	-	-	-	-	-	-	-	-	+
(0xCF)	UDR1	-	-	-		ART1 I/O Data F		-	-	185
(0xCD)	UBRR1H	-	-	-	- 03	, "O Data F	-	te Register High Byte		189/202
(0xCC)	UBRR1L	-	-	-		Baud Rate Regi		to register riigii byte		189/202
(0xCC)	Reserved	-	-	-	- USARTI		-		-	1001202
(0xCA)	UCSR1C	UMSEL11	UMSEL10	UPM11	UPM10	USBS1	UCSZ11/UDORD0 ⁽⁵⁾	UCSZ10/UCPHA0 ⁽⁵⁾	UCPOL1	187/201
(0xC9)	UCSR1B	RXCIE1	TXCIE1	UDRIE1	RXEN1	TXEN1	UCSZ12	RXB81	TXB81	186/200
(0xC8)	UCSR1A	RXC1	TXC1	UDRE1	FE1	DOR1	UPE1	U2X1	MPCM1	185/200
(0xC7)	Reserved	-	-	-	-	-	-	-	-	100/200
(0xCf)	UDR0					ART0 I/O Data F		-	_	185
(0xC5)	UBRR0H	-	-	-	- 5	Data I	•	te Register High Byte		189/202
(0xC4)	UBRR0L					Baud Rate Regi				189/202
(0xC3)	Reserved	-	-	-	-	-	-	-	-	.55/202
(0xC2)	UCSR0C	UMSEL01	UMSEL00	UPM01	UPM00	USBS0	UCSZ01/UDORD0 ⁽⁵⁾	UCSZ00/UCPHA0 ⁽⁵⁾	UCPOL0	187/201
(0xC1)	UCSR0B	RXCIE0	TXCIE0	UDRIE0	RXEN0	TXEN0	UCSZ02	RXB80	TXB80	186/200
(501)	333.10D	LUCUILO		55. NEO	LUCEITO		333202			.55/200



BOSCO UCSRIAN ROCCO TACK UCSRIAN FEB DOMB UFED USDO RF-DAN TREATS	Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(GREPT Reserved	(0xC0)	UCSR0A	RXC0	TXC0	UDRE0	FE0	DOR0	UPE0	U2X0	MPCM0	185/200
(GRIG) TWORK TWO	(0xBF)	Reserved	-		-	-	-	-	-	-	
General Tourist	(0xBE)	Reserved	-	-	-	-	-	-	-	-	
Design TOUR	(0xBD)	TWAMR	TWAM6	TWAM5	TWAM4	TWAM3	TWAM2	TWAM1	TWAM0	-	231
General TWAR	(0xBC)	TWCR	TWINT	TWEA	TWSTA	TWSTO	TWWC	TWEN	-	TWIE	228
Decision TWSR TWSP TWS						1		1		•	
(0.68) (, ,	+		+	1	+	+			+	
Code			TWS7	TWS6	TWS5				TWPS1	TWPS0	
Godes ASSR	· · · · · ·						1	t Rate Register			228
		+						- CORORIUR			455
1969 OCR26								OCR2BUB			155
GNR3 GORRA			-	-	-			nare Pegister B	-	-	155
COMPAIN TOCRES FOCAS FOCAS FOCAS FOCAS CSSS CSSS	· · · · · ·						•				
Gost Gorgan Gor		1									
TOCREA			FOC2A	FOC2B	-				CS21	CS20	
DAMP Reserved			1							+	+
GWAP Reserved							-	-			
(0)AC) Reserved	(0xAE)	Reserved	-	-	-	-	-	-	-	-	
(DuAB) Reserved			-	-	-	-	-	-	-	-	
Dischard Reserved	(0xAC)	Reserved	-	-	-	-	-	-	-	-	
(DAM) Reserved	(0xAB)	Reserved	-	-	-	-	-	-	-	-	
(0xA9) Reserved	(0xAA)	Reserved	-	-	-	-	-	-	-	-	
(0xAr) Reserved -	(0xA9)	Reserved	-	-	-	-	-	-	-	-	
(0)AA9 Reserved	(0xA8)	Reserved	-	-	-	-	-	-	-	-	
(0xA5) Reserved	(0xA7)	-	-	-	-	-	-	-	-	-	
(0)A43 Reserved				ļ		-	-		-	-	
(0xA2) Reserved -	· · · · · ·		-						-	-	
(0)A2) Reserved	· · · · · ·	-		-	-	-	-	-	-	-	
(0xA1) Reserved										-	
(0x86) Reserved	· · · · · ·									1	
(0x96) Reserved -										+	
(0x96) Reserved - - - - - - - - -											
(0x90C) Reserved						-					1
(0x9G) Reserved - -						_				+	
(0x9B) OCR3BH				ļ		1					
(0x9A) OCR3BL	, ,						Output Compare	Register B High Byte ⁽⁷⁾			132
(0x99) OCR3AH											+
(0x97) ICR3H											
(0x96) ICR3L	(0x98)	OCR3AL			7	Fimer/Counter3 - C	Output Compare	Register A Low Byte ⁽⁷⁾			132
Cox95	(0x97)	ICR3H				Timer/Counter3	- Input Capture F	Register High Byte ⁽⁷⁾			133
(0x94) TCNT3L	(0x96)	ICR3L				Timer/Counter3	- Input Capture I	Register Low Byte ⁽⁷⁾			133
(0x93)	(0x95)	TCNT3H				Timer/Counte	r3 - Counter Reç	gister High Byte ⁽⁷⁾			132
(0x92) TCCR3C FOC3A FOC3B -	(0x94)	TCNT3L				Timer/Counte	er3 - Counter Re	gister Low Byte ⁽⁷⁾			132
(0x91) TCCR3B ICNC3 ICES3 - WGM33 WGM32 CS32 CS31 CS30 130 (0x90) TCCR3A COM3A1 COM3A0 COM3B1 COM3B0 -					-	-	-	-	-	-	
(0x90) TCCR3A COM3A1 COM3A0 COM3B1 COM3B0 - - WGM31 WGM30 128							-				
(0x8F) Reserved - - - - - - - - -			1							+	+
(0x8E) Reserved - <		1									128
(0x8D) Reserved - <											
(0x8C) Reserved - <				-	-					-	
(0x8B) OCR1BH Timer/Counter1 - Output Compare Register B High Byte 132	<u> </u>	1		-	-	-	1			-	
(0x8A) OCR1BL Timer/Counter1 - Output Compare Register B Low Byte 132 (0x89) OCR1AH Timer/Counter1 - Output Compare Register A High Byte 132 (0x88) OCR1AL Timer/Counter1 - Output Compare Register A Low Byte 132 (0x87) ICR1H Timer/Counter1 - Input Capture Register High Byte 133 (0x86) ICR1L Timer/Counter1 - Input Capture Register Low Byte 133 (0x85) TCNT1H Timer/Counter1 - Counter Register High Byte 132 (0x84) TCNT1L Timer/Counter1 - Counter Register Low Byte 132 (0x83) Reserved - - - - - (0x82) TCCR1C FOC1A FOC1B - - - - - 131 (0x81) TCCR1B ICNC1 ICES1 - WGM13 WGM12 CS12 CS11 CS10 130 (0x80) TCCR1A COM1A1 COM1B0 - - AIN1D AIN1D AIN0D 234 (0x7F) DIDR0 <td< td=""><td></td><td></td><td>-</td><td>-</td><td></td><td></td><td></td><td></td><td>-</td><td>-</td><td>122</td></td<>			-	-					-	-	122
(0x89) OCR1AH Timer/Counter1 - Output Compare Register A High Byte 132											+
(0x88) OCR1AL Timer/Counter1 - Output Compare Register A Low Byte 132 (0x87) ICR1H Timer/Counter1 - Input Capture Register High Byte 133 (0x86) ICR1L Timer/Counter1 - Input Capture Register Low Byte 133 (0x85) TCNT1H Timer/Counter1 - Counter Register High Byte 132 (0x84) TCNT1L Timer/Counter1 - Counter Register Low Byte 132 (0x83) Reserved - - - - - (0x82) TCCR1C FOC1A FOC1B - - - - - 131 (0x81) TCCR1B ICNC1 ICES1 - WGM13 WGM12 CS12 CS11 CS10 130 (0x80) TCCR1A COM1A1 COM1B0 - - WGM11 WGM10 128 (0x7F) DIDR1 - - - - ADC4D ADC3D ADC2D ADC1D ADC0D 253			 					,			
(0x87) ICR1H Timer/Counter1 - Input Capture Register High Byte 133		-									_
(0x86) ICR1L Timer/Counter1 - Input Capture Register Low Byte 133											+
(0x85) TCNT1H Timer/Counter1 - Counter Register High Byte 132											
(0x84) TCNT1L		+							+		
(0x83) Reserved - <											+
(0x82) TCCR1C FOC1A FOC1B - - - - - - 131 (0x81) TCCR1B ICNC1 ICES1 - WGM13 WGM12 CS12 CS11 CS10 130 (0x80) TCCR1A COM1A1 COM1A0 COM1B1 COM1B0 - - WGM11 WGM10 128 (0x7F) DIDR1 - - - - AIN1D AIN0D 234 (0x7E) DIDR0 ADC7D ADC6D ADC5D ADC4D ADC3D ADC2D ADC1D ADC0D 253			-	-	-				-	-	
(0x80) TCCR1A COM1A1 COM1A0 COM1B1 COM1B0 - - WGM11 WGM10 128 (0x7F) DIDR1 - - - - - - AIN1D AIN0D 234 (0x7E) DIDR0 ADC7D ADC6D ADC5D ADC4D ADC3D ADC2D ADC1D ADC0D 253			FOC1A	FOC1B	-	-	-	-	-	-	131
(0x7F) DIDR1 - - - - - AIN1D AIN0D 234 (0x7E) DIDR0 ADC7D ADC6D ADC5D ADC4D ADC3D ADC2D ADC1D ADC0D 253			ICNC1	ICES1	-	WGM13	WGM12	CS12	CS11	CS10	130
(0x7E) DIDRO ADC7D ADC6D ADC5D ADC4D ADC3D ADC2D ADC1D ADC0D 253	(0x80)	TCCR1A	COM1A1	COM1A0	COM1B1	COM1B0	-	-	WGM11	WGM10	128
	(0x7F)	DIDR1	-	-	-		-	-	AIN1D	AIN0D	234
(0x7D) Reserved	(0x7E)	DIDR0	ADC7D	ADC6D	ADC5D	ADC4D	ADC3D	ADC2D	ADC1D	ADC0D	253
	(0x7D)	Reserved	-	-	-	-	-	-	-	-	



Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(0x7C)	ADMUX	REFS1	REFS0	ADLAR	MUX4	MUX3	MUX2	MUX1	MUX0	249
(0x7B)	ADCSRB	-	ACME	-	-	-	ADTS2	ADTS1	ADTS0	233
(0x7A)	ADCSRA	ADEN	ADSC	ADATE	ADIF	ADIE	ADPS2	ADPS1	ADPS0	250
(0x79)	ADCH			•	ADC	Data Register F	ligh byte		•	251
(0x78)	ADCL				ADC	Data Register L	ow byte			251
(0x77)	Reserved	-	-	-	-	-	-	-	-	
(0x76)	Reserved	-	-	-	-	-	-	-	-	
(0x75)	Reserved	-	-	-	-	-	-	-	-	
(0x74)	Reserved	-	-	-	-	-	-	-	-	
(0x73)	PCMSK3	PCINT31	PCINT30	PCINT29	PCINT28	PCINT27	PCINT26	PCINT25	PCINT24	70
(0x72)	Reserved	-	-	-	-	-	-	-	-	
(0x71)	TIMSK3	-	-	ICIE3	-	-	OCIE3B	OCIE3A	TOIE3	134
(0x70)	TIMSK2	-	-	-	-	-	OCIE2B	OCIE2A	TOIE2	156
(0x6F)	TIMSK1	-	-	ICIE1	-	-	OCIE1B	OCIE1A	TOIE1	134
(0x6E)	TIMSK0 PCMSK2	PCINT23	PCINT22	PCINT21	PCINT20	PCINT19	OCIE0B PCINT18	OCIE0A	TOIE0 PCINT16	105 70
(0x6D)	PCMSK1	PCINT23 PCINT15	PCINT22 PCINT14	PCINT21 PCINT13	PCINT20 PCINT12	PCINT 19 PCINT11	PCINT 16 PCINT 10	PCINT17 PCINT9	PCINT 16 PCINT8	70
(0x6C) (0x6B)	PCMSK0	PCINT7	PCINT 14	PCINT 13	PCINT12 PCINT4	PCINT1	PCINT2	PCINT9	PCINT0	71
(0x6A)	Reserved	-	-	-	-		-	-	-	/ 1
(0x69)	EICRA	-	-	ISC21	ISC20	ISC11	ISC10	ISC01	ISC00	67
(0x68)	PCICR	-	-	-	-	PCIE3	PCIE2	PCIE1	PCIE0	69
(0x67)	Reserved	-	-	-	-	-	-	-	-	
(0x66)	OSCCAL					lator Calibration				40
(0x65)	PRR1	-	-	-	-	-	-	-	PRTIM3	49
(0x64)	PRR0	PRTWI	PRTIM2	PRTIM0	PRUSART1	PRTIM1	PRSPI	PRUSART0	PRADC	48
(0x63)	Reserved	-	-	-	-	-	-	-	-	
(0x62)	Reserved	-	-	-	-	-	-	-	-	
(0x61)	CLKPR	CLKPCE	-	-	-	CLKPS3	CLKPS2	CLKPS1	CLKPS0	40
(0x60)	WDTCSR	WDIF	WDIE	WDP3	WDCE	WDE	WDP2	WDP1	WDP0	59
0x3F (0x5F)	SREG	1	T	Н	S	V	N	Z	С	11
0x3E (0x5E)	SPH	SP15	SP14	SP13	SP12	SP11	SP10	SP9	SP8	12
0x3D (0x5D)	SPL	SP7	SP6	SP5	SP4	SP3	SP2	SP1	SP0	12
0x3C (0x5C)	Reserved	-	-	-	-	-	-	-	-	
0x3B (0x5B)	Reserved	-	-	-	-	-	-	-	-	
0x3A (0x5A)	Reserved	-	-	-	-	-	-	-	-	
0x39 (0x59)	Reserved	-	-	-	-	-	-	-	-	
0x38 (0x58)	Reserved	-	-	-	-	-	- POWET	-	-	005
0x37 (0x57)	SPMCSR	SPMIE -	RWWSB	SIGRD	RWWSRE	BLBSET	PGWRT -	PGERS -	SPMEN	285
0x36 (0x56) 0x35 (0x55)	Reserved MCUCR	JTD	BODS ⁽⁶⁾	BODSE ⁽⁶⁾	PUD	-	-	IVSEL	IVCE	89/268
0x33 (0x53) 0x34 (0x54)	MCUSR	-	-	-	JTRF	WDRF	BORF	EXTRF	PORF	58/268
0x34 (0x54) 0x33 (0x53)	SMCR	-	-	-	JIKF	SM2	SM1	SM0	SE	47
0x33 (0x53)	Reserved	-	-	-	-	- SIVIZ	-	-	- -	47
0x31 (0x51)	OCDR					n-Chip Debug Re				259
0x30 (0x50)	ACSR	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	250
0x2F (0x4F)	Reserved	-	-	-	-	-	-	-	-	200
0x2E (0x4E)	SPDR					SPI 0 Data Regi	ister			166
0x2D (0x4D)	SPSR	SPIF0	WCOL0	-	-	-	-	-	SPI2X0	165
0x2C (0x4C)	SPCR	SPIE0	SPE0	DORD0	MSTR0	CPOL0	CPHA0	SPR01	SPR00	164
0x2B (0x4B)	GPIOR2			•		ral Purpose I/O F	•		•	29
0x2A (0x4A)	GPIOR1					ral Purpose I/O F	-			29
0x29 (0x49)	Reserved	-	-	-	-	-	-	-	-	
0x28 (0x48)	OCR0B				Timer/Coun	ter0 Output Com	pare Register B			105
0x27 (0x47)	OCR0A				Timer/Coun	ter0 Output Com	npare Register A			105
0x26 (0x46)	TCNT0					imer/Counter0 (8 Bit)			105
0x25 (0x45)	TCCR0B	FOC0A	FOC0B	-	-	WGM02	CS02	CS01	CS00	104
0x24 (0x44)	TCCR0A	COM0A1	COM0A0	COM0B1	COM0B0	-	-	WGM01	WGM00	105
0x23 (0x43)	GTCCR	TSM	-	-	-	-	-	PSRASY	PSRSYNC	157
0x22 (0x42)	EEARH	-	-	-	-	<u> </u>		ss Register High Byte		24
0x21 (0x41)	EEARL					Address Regis	-			24
0x20 (0x40)	EEDR			T	1	EPROM Data Re		T	Г	24
0x1F (0x3F)	EECR	-	-	EEPM1	EEPM0	EERIE	EEMPE	EEPE	EERE	24
0x1E (0x3E)	GPIOR0				Gene	ral Purpose I/O F		· · · - ·		29
0x1D (0x3D)	EIMSK	-	-	-	-	-	INT2	INT1	INTO	68
0x1C (0x3C)	EIFR	-	-	-	-	- DOIT2	INTF2	INTF1	INTF0	68
0x1B (0x3B)	PCIFR	-	-	-	-	PCIF3	PCIF2	PCIF1	PCIF0	69
0x1A (0x3A)	Reserved	-	-	-	-	-	-	-	-	-
0x19 (0x39)	Reserved	-	-	-	-	-	-	-	-	1



Mnemonics	Operands	Operands Description Operation		Flags	#Clocks
MCU CONTROL INS	TRUCTIONS				
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep function)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR/timer)	None	1
BREAK		Break	For On-chip Debug Only	None	N/A



Ordering information 9.

9.1 **Atmel ATmega164A**

Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega164A-AU ATmega164A-PU ATmega164A-MU ATmega164A-MU ATmega164A-MUR ⁽⁵⁾ ATmega164A-MCH ⁽⁴⁾ ATmega164A-MCHR ⁽⁴⁾ ATmega164A-CU ATmega164A-CU	44A 44A 40P6 44M1 44M1 44MC 44MC 49C2 49C2	Industrial (-40°C to 85°C)

- Notes: 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 3. For Speed vs. V_{CC} see "Speed grades" on page 324.
 - 4. NiPdAu Lead Finish.
 - 5. Tape & Reel.

	Package Type
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN)
44MC	44-lead (2-row Staggered), 5 × 5 × 1.0mm body, 2.60 × 2.60mm Exposed Pad, Quad Flat No-Lead Package (QFN)
49C2	49-ball, (7 × 7 Array) 0.65mm Pitch, 5 × 5 × 1mm, Very Thin, Fine-Pitch Ball Grid Array Package (VFBGA)



Atmel ATmega324PA 9.4

Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega324PA-AU ATmega324PA-AUR ⁽⁵⁾ ATmega324PA-PU ATmega324PA-MU ATmega324PA-MUR ⁽⁵⁾ ATmega324PA-MCH ⁽⁴⁾ ATmega324PA-MCHR ⁽⁴⁾⁽⁵⁾ ATmega324PA-CU ATmega324PA-CU	44A 44A 40P6 44M1 44M1 44MC 44MC 49C2 49C2	Industrial (-40°C to 85°C)
20	1.8 - 5.5V	ATmega324PA-AN ATmega324PA-ANR ⁽⁵⁾ ATmega324PA-PN ATmega324PA-MN ATmega324PA-MNR ⁽⁵⁾	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 105°C)

- Notes: 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 3. For Speed vs. V_{CC} see "Speed grades" on page 324.
 - 4. NiPdAu Lead Finish.
 - 5. Tape & Reel.

	Package Type
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN)
44MC	44-lead (2-row Staggered), 5 × 5 × 1.0mm body, 2.60 × 2.60mm Exposed Pad, Quad Flat No-Lead Package (QFN)
49C2	49-ball, (7 × 7 Array) 0.65mm Pitch, 5 × 5 × 1mm, Very Thin, Fine-Pitch Ball Grid Array Package (VFBGA)



Atmel ATmega644PA 9.6

Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega644PA-AU ATmega644PA-AUR ⁽⁴⁾ ATmega644PA-PU ATmega644PA-MU ATmega644PA-MUR ⁽⁴⁾	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 85°C)
20	1.8 - 5.5V	ATmega644PA-AN ATmega644PA-ANR ⁽⁴⁾ ATmega644PA-PN ATmega644PA-MN ATmega644PA-MNR ⁽⁴⁾	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 105°C)

- Notes: 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 3. For Speed vs. V_{CC} see "Speed grades" on page 324.
 - 4. Taper & Reel.

Package Type			
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)		
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)		
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN)		



Atmel ATmega1284P 9.8

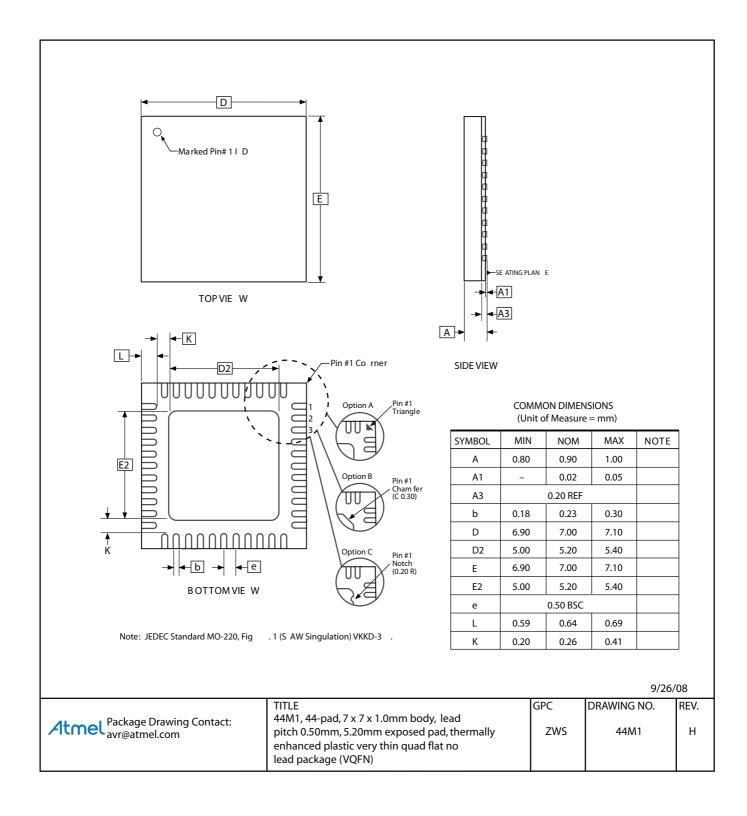
Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega1284P-AU ATmega1284P-AUR ⁽⁴⁾ ATmega1284P-PU ATmega1284P-MU ATmega1284P-MUR ⁽⁴⁾	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 85°C)
20	1.8 - 5.5V	ATmega1284P-AN ATmega1284P-ANR ⁽⁴⁾ ATmega1284P-PN ATmega1284P-MN ATmega1284P-MNR ⁽⁴⁾	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 105°C)

- Notes: 1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
 - 2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 - 3. For Speed vs. V_{CC} see "Speed grades" on page 324.
 - 4. Tape & Reel.

Package Type				
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)			
40P6	40-pin, 0.600" Wide, Plastic Dual Inline Package (PDIP)			
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)			

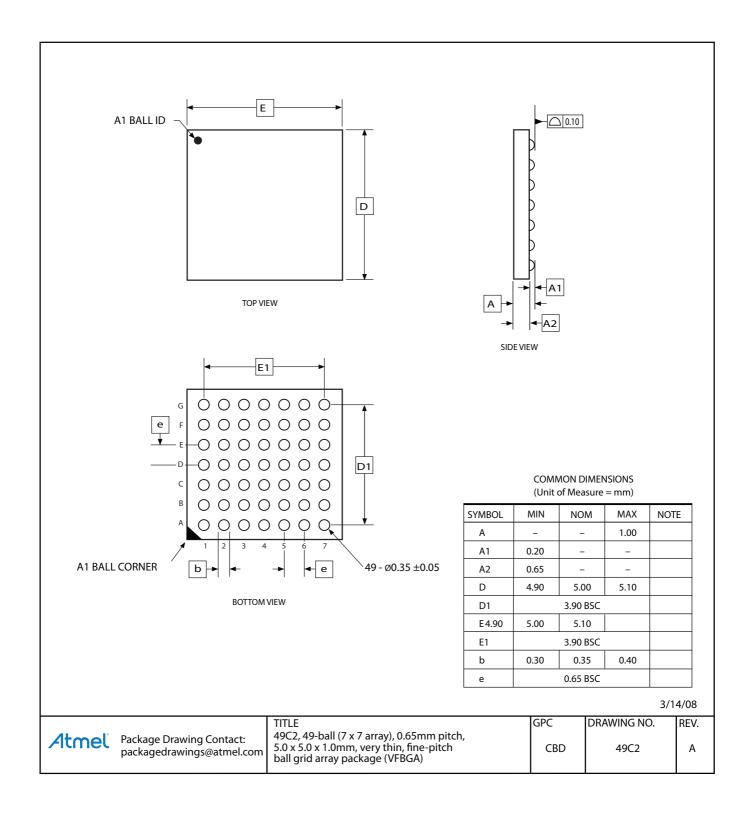


10.3 44M1





10.5 49C2





12. Datasheet revision history

Please note that the referring page numbers in this section are referred to this document. The referring revision in this section are referring to the document revision.

12.1 Rev. 8272G - 01/2015

- 1. Updated Table 1-2 on page 5, Table 8-1 on page 25, Table 10-1 on page 42, Table 14-3 on page 79, Table 19-4 on page 187, Table 19-11 on page 192 and Table 28-16 on page 328 for formatting consistency errors
 - Updated "Ordering information" on page 17:
- Added ordering information for ATmega164PA @105°C; ATmega324PA @ 105°C; ATmega324PA @105°C; ATmega644PA @ 105°C and ATmega1284P @ 105°C
- Updated the "Packaging information" on page 25:
 - Replaced the drawing "44M1" on page 27 by a correct package

12.2 Rev. 8272F - 08/2014

- 1. Updated text in Section 13.2.8 "PCMSK1 Pin Change Mask Register 1" on page 70 to: "If PCINT15:8 is set and the PCIE1 bit in PCICR is set, pin change interrupt is enabled on the corresponding I/O pin."
- 2. Corrected description of PAGEMSB in Table 26-9 on page 281. The device has 64 words in a page and not 128.
- 3. Corrected description of PAGEMSB in Table 26-12 on page 282. PAGESMB is 5 and the device has 64 words in a page and not 128. The page require six bits and not seven.
- 4. Corrected values in Table 26-16 on page 284. PAGEMSB is 6. ZPAGEMSB is Z7 and PCPAGE is Z15:Z8
- 5. Corrected value for PCPAGE in Table 27-7 on page 290. The correct value is PC[14:7]
- 6. Updated description in Table 17-2 on page 151 to "Normal port operation, OC2A disconnected."
 - Updated Assembly code examples on for "Watchdog Timer" on page 55. and onwards
- 7. "out WDTCSR, r16" changed to "sts WDTCSR, r16" "in r16, WDTCSR" changed to "lds r16, WDTCSR" "idi r16, WDTCSR" changed to "lds r16, WDTCSR"
- 8. Updated addresses 0x65 and 0x64 in Section 7. "Register summary" on page 10.
- 9. Removed notes 5 and 6 from Table 28-16 on page 328.
- 10. Corrected values in Section 8. "Instruction set summary" on page 14. Changed clock values for RCALL and ICALL to 2, for Call, Ret and RETI to 4. Also changed values in Section 7.7.1 "Interrupt response time" on page 18.
- 11. Updated layout, footer and back page according to template 0205/2014



12.3 Rev. 8272E - 04/2013

- 1. Updated Figure 1-1 on page 3 and Figure 2-1 on page 6: T3 and T/C3 only available in ATmega1284/1284P.
- 2. Updated descriptive text on page 6 to indicate that ATmega1284/1284P has four T/Cs.
- 3. Updated the Assembly code example for WDT off (p.56) following the ei# 705736.
- 4. Added note in "16-bit Timer/Counter1 and Timer/Counter3⁽¹⁾ with PWM" on page 107.
- 5. Added "Prescaler Reset" on page 112.
- 6. Corrected three typo for Waveform generation mode (WGM) instead of MGM.
- 7. Updated Table 23-6 on page 253. ADC Auto Trigger Source Selections, ADTS=0b011, the statement is Timer/Counter0 Compare Match A.
- 8. Updated Table 27-18 on page 310. Command for 6d Poll for Fuse Write Complete: 0111011 00000000
- 9. Updated the table notes of the Table 28-1 on page 318.
- 10. Updated "Register summary" on page 10. Added table note 7: Only available in ATmega1284/1284P.

12.4 Rev. 8272D - 05/12

- 1. Updated "Power-down mode" on page 44.
- 2. Updated "Overview" on page 67.
- 3. Corrected references for Bit 2, Bit 1, and Bit 0 in Section "UCSRnC USART MSPIM Control and Status Register n C" on page 201.
- 4. Several small corrections throughout the whole document made according to the template
- 5. Notes in Table 27-17 on page 304 have been corrected
- 6. Note (1) in Table 28-3 on page 320 is added

12.5 Rev. 8272C - 06/11

1. Updated "Atmel ATmega1284P DC characteristics" on page 323.

12.6 Rev. 8272B - 05/11

- 1. Added Atmel QTouch Library Support and QTouch Sensing Capability Features.
- 2. Replaced the Figure 1-1 on page 3 by an updated "Pinout." that includes Timer/Counter3.
- 3. Replaced the Figure 7-1 on page 10 by an updated "Block diagram of the AVR architecture." that includes Timer/Counter3.
- 4. Added "RAMPZ Extended Z-pointer Register for ELPM/SPM⁽¹⁾" on page 15.
- 5. Added "PRR1 Power Reduction Register 1" on page 49.
- 6. Renamed PRR to "PRR0 Power Reduction Register 0" on page 48.
- 7. Updated "PCIFR Pin Change Interrupt Flag Register" on page 69. PCICR replaces EIMSR in the PCIF3, PCIF2, PCIF1 and PCIF0 bit description.
- 8. Updated "PCMSK3 Pin Change Mask Register 3" on page 70. PCIE3 replaces PCIE2 in the bit description.
- 9. Updated "Alternate Functions of Port B" on page 80 to include Timer/Counter3
- 10. Updated "Alternate Functions of Port D" on page 86 to include Timer/Counter3
- 11. Added "TCNT3H and TCNT3L –Timer/Counter3" on page 132



- 12. Added "OCR3AH and OCR3AL Output Compare Register3 A" on page 133
- 13. Added "OCR3BH and OCR3BL Output Compare Register3 B" on page 133
- 14. Added "TIMSK3 Timer/Counter3 Interrupt Mask Register" on page 134
- 15. Updated All "SPI Serial Peripheral Interface" "Register description" to reflect ATmega1284 and ATmega1284P.
- 16. Updated "Addressing the Flash During Self-Programming" on page 274 to include RAMPZ register.
- 17. Updated Table 27-16 on page 303. t_{WD_EEPROM} is 3.6ms instead of 9ms.
- 18. BODS and BODSE bits denoted as R/W
- 19. Description of external pin modes below table 16-9 removed.
- 20. Updated "Register summary" on page 10 to include Timer/Counter3.
- 21. Updated the datasheet with Atmel new style guide.

12.7 Rev. 8272A - 01/10

- 1. Initial revision (Based on the ATmega164PA/324PA/644PA/1284P datasheet 8252G-AVR-11/09 and on the ATmega644 datasheet 2593N-AVR-09/09).
- 2. Changes done:
 - Non-picoPower devices added: ATmega164A/324A/644A/1284
 - Updated Table 2-1 on page 7
 - Updated Table 10-1 on page 42
 - Updated "Sleep Modes" on page 42 and "BOD disable⁽¹⁾" on page 43
 - Updated "Register description" on page 67
 - Updated "USART" on page 167 and "USART in SPI mode" on page 194
 - Updated "Signature Bytes" on page 290 and "Page Size" on page 290
 - Added "DC Characteristics" on page 318 for non-picoPower devices.
 - Added "Atmel ATmega164A typical characteristics" on page 333
 - Added "Atmel ATmega324A typical characteristics" on page 386
 - Added "Atmel ATmega644A typical characteristics" on page 438
 - Added "ATmega1284 typical characteristics" on page 490
 - Added "Ordering information" on page 17 for non-picoPower devices
 - Added "Errata for ATmega164A" on page 30
 - Added "Errata for ATmega324A" on page 30
 - Added "Errata for ATmega644PA" on page 30
 - Added "Errata for ATmega1284" on page 30











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